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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Not For New Designs
Core Processor	RX
Core Size	32-Bit Single-Core
Speed	100MHz
Connectivity	CANbus, EBI/EMI, Ethernet, I ² C, LINbus, SCI, SPI, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	133
Program Memory Size	1MB (1M x 8)
Program Memory Type	FLASH
EEPROM Size	32K x 8
RAM Size	128K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 3.6V
Data Converters	A/D 8x10b, 21x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	176-LQFP
Supplier Device Package	176-LFQFP (24x24)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f563nbcdfc-v0

1. Overview

1.1 Outline of Specifications

Table 1.1 lists the specifications in outline, and table 1.2 gives a comparison of the functions of products in different packages.

Table 1.1 is for products with the greatest number of functions, so numbers of peripheral modules and channels will differ in accord with the package. For details, see Table 1.2, Comparison of Functions for Different Packages in the RX63N/RX631 Group.

Table 1.1 Outline of Specifications (1/6)

Classification	Module/Function	Description
CPU	CPU	- Maximum operating frequency: 100 MHz 32-bit RX CPU - Minimum instruction execution time: One instruction per state (cycle of the system clock) - Address space: 4-Gbyte linear - Register set of the CPU - General purpose: Sixteen 32-bit registers - Control: Nine 32-bit registers - Accumulator: One 64-bit register - Basic instructions: 73 - Floating-point instructions: 8 - DSP instructions: 9 - Addressing modes: 10 - Data arrangement - Instructions: Little endian - Data: Selectable as little endian or big endian - On-chip 32-bit multiplier: 32 x 32 → 64 bits - On-chip divider: 32 / 32 → 32 bits - Barrel shifter: 32 bits - Memory protection unit (MPU)
	FPU	- Single precision (32-bit) floating point - Data types and floating-point exceptions in conformance with the IEEE754 standard
Memory	ROM	- Capacity: ROMless, 256 Kbytes, 384 Kbytes, 512 Kbytes, 768 Kbytes, 1 Mbyte, 1.5 Mbytes, 2 Mbytes 100 MHz, no-wait access - On-board programming: Four types - Off-board programming (parallel programmer mode) (for products with 100 pins or more)
	RAM	- Capacity: 64 Kbytes, 128 Kbytes, 192 Kbytes, 256 Kbytes 100 MHz, no-wait access
	E2 data flash	Capacity: 32 Kbytes Programming/erasing: 100,000 times
MCU operating modes		Single-chip mode, on-chip ROM enabled expansion mode, and on-chip ROM disabled expansion mode (software switching)
Clock	Clock generation circuit	- Main clock oscillator, subclock oscillator, low-speed/high-speed on-chip oscillator, PLL frequency synthesizer, and IWDG-dedicated on-chip oscillator - Main-clock oscillation stoppage detection - Separate frequency-division and multiplication settings for the system clock (ICLK), peripheral module clock (PCLK), FlashIF clock (FCLK) and external bus clock (BCLK) The CPU and other bus masters run in synchronization with the system clock (ICLK): Up to 100 MHz Peripheral modules run in synchronization with the peripheral module clock (PCLK): Up to 50 MHz Flash IF run in synchronization with the flashIF clock (FCLK): Up to 50 MHz Devices connected to the external bus run in synchronization with the external bus clock (BCLK): Up to 50 MHz
Reset		RES# pin reset, power-on reset, voltage-monitoring reset, independent watchdog timer reset, watchdog timer reset, deep software standby reset, and software reset
Voltage detection circuit		When the voltage on VCC passes the voltage detection level (Vdet), an internal reset or internal interrupt is generated.

Table 1.1 Outline of Specifications (4/6)

Classification	Module/Function	Description
Timers	16-bit timer pulse unit (TPUa)	• (16 bits x 6 channels) x 2 unit • Maximum of 16 pulse-input/output possible • Select from among seven or eight counter-input clock signals for each channel • Input capture/output compare function • Output of PWM waveforms in up to 15 phases in PWM mode • Buffered operation and phase-counting mode (two phase encoder input) depending on the channel • Support for cascade-connected operation (32 bits x 2 channels) • PPG output trigger can be generated • Capable of generating conversion start triggers for the A/D converters • Signals from the input capture pins are input via a digital filter • Clock frequency measuring method
	Multi-function timer pulse unit 2 (MTU2a)	• (16 bits x 6 channels) x 1 unit • Time bases for the 6 x 16-bit timer channels can be provided via up to sixteen pulse-input/output lines and three pulse-input lines • Select from among eight counter-input clock signals for each channel (PCLK/1, PCLK/4, PCLK/16, PCLK/64, MTCLKA, MTCLKB, MTCLKC, MTCLKD) other than channel 5, for which only four signals are available. • Input capture function • 21 output compare/input capture registers • Complementary PWM output mode • Reset synchronous PWM mode • Phase-counting mode • Generation of triggers for A/D converter conversion • Digital filter • Signals from the input capture pins are input via a digital filter • PPG output trigger can be generated • Clock frequency measuring function
	Frequency measuring method (MCK)	The MTU or unit 0 TPU module can be used to monitor the main clock, subclock, HOCO clock, LOCO clock, and PLL clock for abnormal frequencies.
	Port output enable 2 (POE2a)	Controls the high-impedance state of the MTU's waveform output pins
	Programmable pulse generator (PPG)	• (4 bits x 4 groups) x 2 units • Pulse output with the MTU2 or TPU output as a trigger • Maximum of 32 pulse-output possible
	8-bit timers (TMR)	• (8 bits x 2 channels) x 2 units • Select from among seven internal clock signals (PCLK/1, PCLK/2, PCLK/8, PCLK/32, PCLK/64, PCLK/1024, PCLK/8192) and one external clock signal • Capable of output of pulse trains with desired duty cycles or of PWM signals • The 2 channels of each unit can be cascaded to create a 16-bit timer • Generation of triggers for A/D converter conversion • Capable of generating baud-rate clocks for SCI5, SCI6, and SCI12
	Compare match timer (CMT)	• (16 bits x 2 channels) x 2 units • Select from among four internal clock signals (PCLK/8, PCLK/32, PCLK/128, PCLK/512)
	Realtime clock (RTCa)	• Clock sources: Main clock, subclock • Clock and calendar functions • Interrupt sources: Alarm interrupt, periodic interrupt, and carry interrupt • Battery backup operation • Time-capture facility for three values
	Watchdog timer (WDTa)	• 14 bits x 1 channel • Select from among 6 counter-input clock signals (PCLK/4, PCLK/64, PCLK/128, PCLK/512, PCLK/2048, PCLK/8192)
	Independent watchdog timer (IWDTa)	• 14 bits x 1 channel • Counter-input clock: IWDT-dedicated on-chip oscillator • Dedicated clock/1, dedicated clock/16, dedicated clock/32, dedicated clock/64, dedicated clock/128, dedicated clock/256

1.4 Pin Functions

Table 1.4 lists the pin functions.

Table 1.4 Pin Functions (1/6)

Classifications	Pin Name	I/O	Description
Power supply	VCC	Input	Power supply pin. Connect it to the system power supply. Connect this pin to VSS via a 0.1-μF capacitor. The capacitor should be placed close to the pin.
	VCL	Input	Connect this pin to VSS via a 0.1-μF capacitor. The capacitor should be placed close to the pin.
	VSS	Input	Ground pin. Connect it to the system power supply (0 V).
	VBATT	Input	Backup power pin. When the battery backup function is not to be used, connect it to the VCC pin.
Clock	XTAL	Output	Pins for a crystal resonator. An external clock signal can be input through the EXTAL pin.
	EXTAL	Input	
	BCLK	Output	Outputs the external bus clock for external devices.
	SDCLK	Output	Outputs the clock dedicated for the SDRAM.
	XCOUT	Output	Input/output pins for the subclock oscillator. Connect a crystal resonator between XCOUT and XCIN.
	XCIN	Input	
Operating mode control	MD	Input	Pins for setting the operating mode. The signal levels on these pins must not be changed during operation.
System control	RES#	Input	Reset signal input pin. This LSI enters the reset state when this signal goes low.
	EMLE	Input	Input pin for the on-chip emulator enable signal. When the on-chip emulator is used, this pin should be driven high. When not used, it should be driven low.
	BSCANP	Input	Boundary scan enable pin. Boundary scan is enabled when this pin goes high. When not used, it should be driven low.
On-chip emulator	FINEC	Input	Fine interface clock pin
	FINED	I/O	Fine interface pin
	TRST#	Input	On-chip emulator or boundary scan pins. When the EMLE pin is driven high, these pins are dedicated for the on-chip emulator.
	TMS	Input	
	TDI	Input	
	TCK	Input	
	TDO	Output	This pin outputs the clock for synchronization with the trace data.
	TRCLK	Output	
	TRSYNC	Output	This pin indicates that output from the TRDATA0 to TRDATA3 pins is valid.
	TRDATA0 to TRDATA3	Output	These pins output the trace information.
Address bus	A0 to A23	Output	Output pins for the address.
Data bus	D0 to D31	I/O	Input and output pins for the bidirectional data bus.
Multiplexed bus	A0/D0 to A15/D15	I/O	Address/data multiplexed bus

	A	B	C	D	E	F	G	H	J	K	L	M	N	
13	PE3	PE4	VSS	PE6	P67	PA2	PA4	PA7	PB1	PB5	VSS	VCC	P74	13
12	PE1	PE2	P70	PE5	P65	PA1	VCC	PB0	PB2	PB6	P73	PC1	P75	12
11	P62	P61	PE0	VCC	P66	VSS	PA6	P71	PB4	PB7	PC2	PC0	PC3	11
10	VSS	VCC	P63	PE7	PA0	PA3	PA5	P72	PB3	P76	PC4	P77	P82	10
9	PD6	PD4	PD7	P64	RX63N Group RX631 Group PTLG0145KA-A (145-pin TFLGA) (Top perspective view)					P80	PC5	P81	PC7	9
8	PD2	PD0	PD3	P60						VCC	P83	PC6	VSS	8
7	P92	P91	PD1	PD5						P51	P52	P50	P55	7
6	P90	P47	VSS	P93						P53	P56	VSS_ USB	USB0_ DP	6
5	P45	P43	P46	VCC	P44					P54	P13	VCC_ USB	USB0_ DM	5
4	P42	VREFL0	P41	P01	EMLE	VBATT	BSCANP	P35	P30	P15	P24	P12	P14	4
3	P40	P05	VREFH0	P03	PJ5	PJ3	MD/ FINED	VSS	P32	P31	P16	P86	P87	3
2	P07	AVCC0	P02	PF5	VCL	XCOUT	RES#	VCC	P33	P26	P23	P17	P20	2
1	AVSS0	VREFH	VREFL	P00	VSS	XCIN	XTAL	EXTAL	P34	P27	P25	P22	P21	1
	A	B	C	D	E	F	G	H	J	K	L	M	N	

Note: This figure indicates the power supply pins and I/O port pins. For the pin configuration, see Table 1.7, List of Pins and Pin Functions (145-Pin TFLGA).

Figure 1.6 Pin Assignment (145-Pin TFLGA)

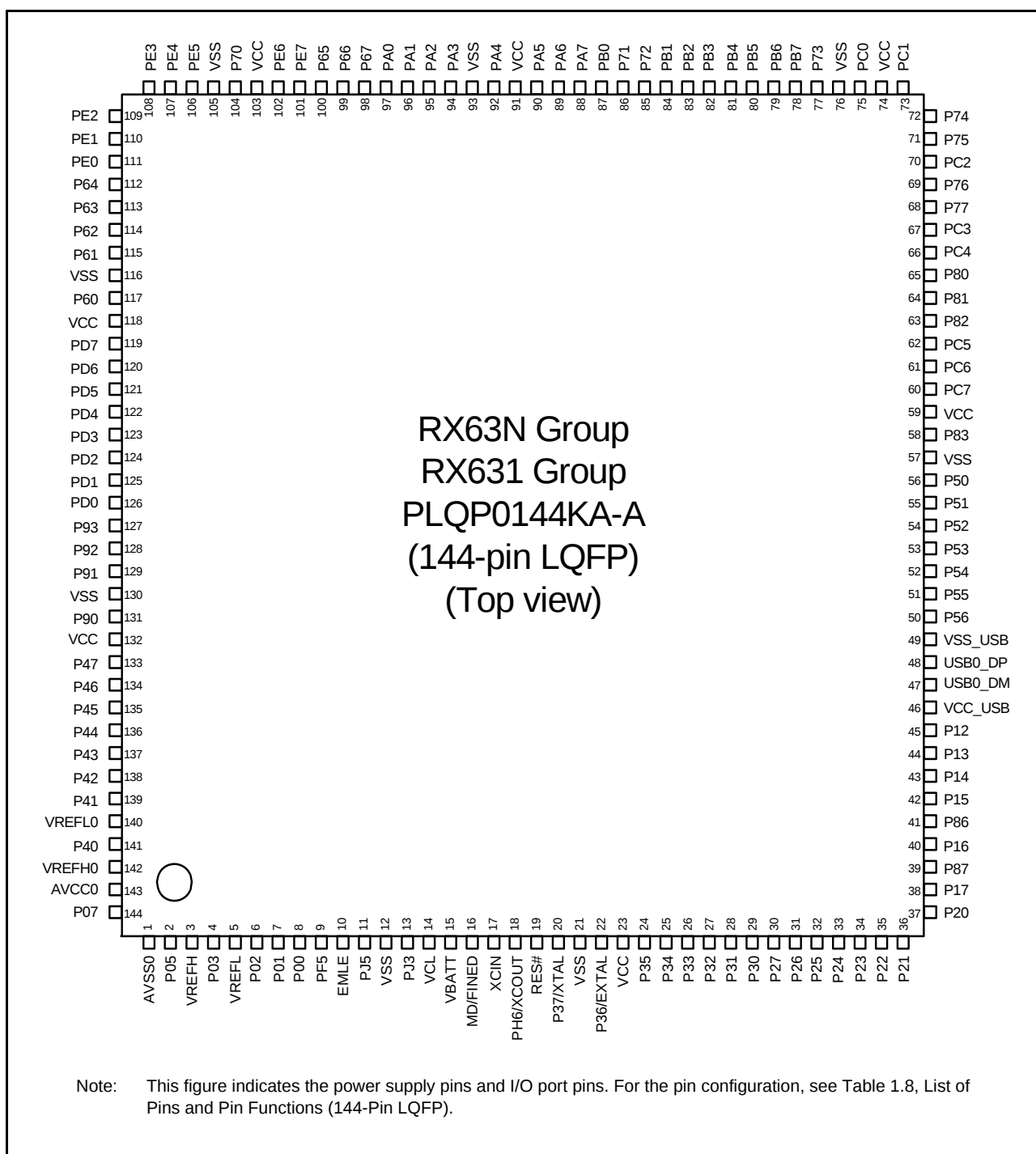
**Figure 1.7 Pin Assignment (144-Pin LQFP)**

Table 1.9 List of Pins and Pin Functions (100-Pin TFLGA) (4/5)

Pin No. 100-pin TFLGA	Power Supply Clock System Control	I/O Port	Bus EXDMAC	Timers (MTU, TPU, TMR, PPG, RTC, POE)	Communications (ETHERC, SCIC, SCID, RSPI, RIIC, CAN, IEB, USB)	Interrupt	S12AD AD DA
H4		P15		MTIOC0B/ MTCLKB/ TIOCB2/ TCLKB/TMCI2/ PO13	RXD1/SCK3/ SMISO1/SSCL1/ CRX1-DS	IRQ5	
H5		P55	WAIT#/ EDREQ0	MTIOC4D/ TMO3	CRX1/ET_EXOUT	IRQ10	
H6		P54	ALE/EDACK0	MTIOC4B/ TMCI1	CTS2#/RTS2#/ SS2#/CTX1/ ET_LINKSTA		
H7		PC7	A23/CS0#	MTIOC3A/ MTCLKB/ TMO2/PO31	TXD8/SMOSI8/ SSDA8/MISOA/ ET_COL	IRQ14	
H8		PC6	A22/CS1#	MTIOC3C/ MTCLKA/ TMCI2/PO30	RXD8/SMISO8/ SSCL8/MOSIA/ ET_ETXD3	IRQ13	
H9		PB6	A14	MTIOC3D/ TIOCA5/PO30	RXD9/SMISO9/ SSCL9/ET_ETXD1/ RMII_TXD1		
H10		PB7	A15	MTIOC3B/ TIOCB5/PO31	TXD9/SMOSI9/ SSDA9/ET_CRS/ RMII_CRS_DV		
J1		P24	CS4#/ EDREQ1	MTIOC4A/ MTCLKA/ TIOCB4/ TMR1/PO4	SCK3/ USB0_VBUSEN		
J2		P21		MTIOC1B/ TIOCA3/ TMCI0/PO1	RXD0/SMISO0/ SSCL0/ USB0_EXICEN	IRQ9	
J3		P17		MTIOC3A/ MTIOC3B/ TIOCB0/ TCLKD/TMO1/ PO15/POE8#	SCK1/TXD3/ SMOSI3/SSDA3/ MISOA/SDA2-DS/ IETXD	IRQ7	ADTRG#
J4		P13		MTIOC0B/ TIOCA5/TMO3/ PO13	TXD2/SMOSI2/ SSDA2/SDA0[FM+]	IRQ3	ADTRG#
J5	VSS_USB						
J6	VCC_USB						
J7		P50	WR0#/WR#		TXD2/SMOSI2/ SSDA2/SSLB1		
J8		PC4	A20/CS3#	MTIOC3D/ MTCLKC/ TMCI1/PO25/ POE0#	SCK5/CTS8#/ RTS8#/SS8#/ SSLA0/ET_TX_CLK		
J9		PC0	A16	MTIOC3C/ TCLKC/PO17	CTS5#/RTS5#/ SS5#/SSLA1/ ET_ERXD3	IRQ14	
J10		PC1	A17	MTIOC3A/ TCLKD/PO18	SCK5/SSLA2/ ET_ERXD2	IRQ12	
K1		P23	EDACK0	MTIOC3D/ MTCLKD/ TIOCD3/PO3	TXD3/CTS0#/ RTS0#/SMOSI3/ SS0#/SSDA3/ USB0_DPUPE		

Table 4.1 List of I/O Registers (Address Order) (3/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK>PCLK	ICLK<PCLK	
0008 2818h	EXDMAC0	EXDMA offset register	EDMOFR	32	32	1, 2 BCLK		EXDMACa
0008 281Ch	EXDMAC0	EXDMA transfer enable register	EDMCNT	8	8	1, 2 BCLK		
0008 281Dh	EXDMAC0	EXDMA software start register	EDMREQ	8	8	1, 2 BCLK		
0008 281Eh	EXDMAC0	EXDMA status register	EDMSTS	8	8	1, 2 BCLK		
0008 2820h	EXDMAC0	EXDMA external request sense mode register	EDMRMD	8	8	1, 2 BCLK		
0008 2821h	EXDMAC0	EXDMA external request flag register	EDMERF	8	8	1, 2 BCLK		
0008 2822h	EXDMAC0	EXDMA peripheral request flag register	EDMPRF	8	8	1, 2 BCLK		
0008 2840h	EXDMAC1	EXDMA source address register	EDMSAR	32	32	1, 2 BCLK		
0008 2844h	EXDMAC1	EXDMA destination address register	EDMDAR	32	32	1, 2 BCLK		
0008 2848h	EXDMAC1	EXDMA transfer count register	EDMCRA	32	32	1, 2 BCLK		
0008 284Ch	EXDMAC1	EXDMA block transfer count register	EDMCRB	16	16	1, 2 BCLK		
0008 2850h	EXDMAC1	EXDMA transfer mode register	EDMTMD	16	16	1, 2 BCLK		
0008 2852h	EXDMAC1	EXDMA output setting register	EDMOMD	8	8	1, 2 BCLK		
0008 2853h	EXDMAC1	EXDMA interrupt setting register	EDMINT	8	8	1, 2 BCLK		
0008 2854h	EXDMAC1	EXDMA address mode register	EDMAMD	32	32	1, 2 BCLK		
0008 285Ch	EXDMAC1	EXDMA transfer enable register	EDMCNT	8	8	1, 2 BCLK		
0008 285Dh	EXDMAC1	EXDMA software start register	EDMREQ	8	8	1, 2 BCLK		
0008 285Eh	EXDMAC1	EXDMA status register	EDMSTS	8	8	1, 2 BCLK		
0008 2860h	EXDMAC1	EXDMA external request sense mode register	EDMRMD	8	8	1, 2 BCLK		
0008 2861h	EXDMAC1	EXDMA external request flag register	EDMERF	8	8	1, 2 BCLK		
0008 2862h	EXDMAC1	EXDMA peripheral request flag register	EDMPRF	8	8	1, 2 BCLK		
0008 2A00h	EXDMAC	EXDMA module start register	EDMAST	8	8	1, 2 BCLK		
0008 2BE0h	EXDMAC	Cluster buffer register 0	CLSBR0	32	32	1, 2 BCLK		
0008 2BE4h	EXDMAC	Cluster buffer register 1	CLSBR1	32	32	1, 2 BCLK		
0008 2BE8h	EXDMAC	Cluster buffer register 2	CLSBR2	32	32	1, 2 BCLK		
0008 2BECh	EXDMAC	Cluster buffer register 3	CLSBR3	32	32	1, 2 BCLK		
0008 2BF0h	EXDMAC	Cluster buffer register 4	CLSBR4	32	32	1, 2 BCLK		
0008 2BF4h	EXDMAC	Cluster buffer register 5	CLSBR5	32	32	1, 2 BCLK		
0008 2BF8h	EXDMAC	Cluster buffer register 6	CLSBR6	32	32	1, 2 BCLK		
0008 2BFCh	EXDMAC	Cluster buffer register 7	CLSBR7	32	32	1, 2 BCLK		
0008 3002h	BSC	CS0 mode register	CS0MOD	16	16	1, 2 BCLK		Buses
0008 3004h	BSC	CS0 wait control register 1	CS0WCR1	32	32	1, 2 BCLK		
0008 3008h	BSC	CS0 wait control register 2	CS0WCR2	32	32	1, 2 BCLK		
0008 3012h	BSC	CS1 mode register	CS1MOD	16	16	1, 2 BCLK		
0008 3014h	BSC	CS1 wait control register 1	CS1WCR1	32	32	1, 2 BCLK		
0008 3018h	BSC	CS1 wait control register 2	CS1WCR2	32	32	1, 2 BCLK		
0008 3022h	BSC	CS2 mode register	CS2MOD	16	16	1, 2 BCLK		
0008 3024h	BSC	CS2 wait control register 1	CS2WCR1	32	32	1, 2 BCLK		
0008 3028h	BSC	CS2 wait control register 2	CS2WCR2	32	32	1, 2 BCLK		
0008 3032h	BSC	CS3 mode register	CS3MOD	16	16	1, 2 BCLK		
0008 3034h	BSC	CS3 wait control register 1	CS3WCR1	32	32	1, 2 BCLK		
0008 3038h	BSC	CS3 wait control register 2	CS3WCR2	32	32	1, 2 BCLK		
0008 3042h	BSC	CS4 mode register	CS4MOD	16	16	1, 2 BCLK		
0008 3044h	BSC	CS4 wait control register 1	CS4WCR1	32	32	1, 2 BCLK		
0008 3048h	BSC	CS4 wait control register 2	CS4WCR2	32	32	1, 2 BCLK		
0008 3052h	BSC	CS5 mode register	CS5MOD	16	16	1, 2 BCLK		
0008 3054h	BSC	CS5 wait control register 1	CS5WCR1	32	32	1, 2 BCLK		
0008 3058h	BSC	CS5 wait control register 2	CS5WCR2	32	32	1, 2 BCLK		
0008 3062h	BSC	CS6 mode register	CS6MOD	16	16	1, 2 BCLK		
0008 3064h	BSC	CS6 wait control register 1	CS6WCR1	32	32	1, 2 BCLK		
0008 3068h	BSC	CS6 wait control register 2	CS6WCR2	32	32	1, 2 BCLK		

Table 4.1 List of I/O Registers (Address Order) (19/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 8313h	RIIC0	I ² C bus receive data register	ICDRR	8	8	2, 3 PCLKB	2 ICLK	RIIC
0008 8320h	RIIC1	I ² C bus control register 1	ICCR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8321h	RIIC1	I ² C bus control register 2	ICCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8322h	RIIC1	I ² C bus mode register 1	ICMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8323h	RIIC1	I ² C bus mode register 2	ICMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8324h	RIIC1	I ² C bus mode register 3	ICMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 8325h	RIIC1	I ² C bus function enable register	ICFER	8	8	2, 3 PCLKB	2 ICLK	
0008 8326h	RIIC1	I ² C bus status enable register	ICSER	8	8	2, 3 PCLKB	2 ICLK	
0008 8327h	RIIC1	I ² C bus interrupt enable register	ICIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8328h	RIIC1	I ² C bus status register 1	ICSR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8329h	RIIC1	I ² C bus status register 2	ICSR2	8	8	2, 3 PCLKB	2 ICLK	
0008 832Ah	RIIC1	Slave address register L0	SARL0	8	8	2, 3 PCLKB	2 ICLK	
0008 832Ah	RIIC1	Timeout Internal Counter L	TMOCNTL	8	8	2, 3 PCLKB	2 ICLK	
0008 832Bh	RIIC1	Slave address register U0	SARU0	8	8	2, 3 PCLKB	2 ICLK	
0008 832Bh	RIIC1	Timeout Internal Counter U	TMOCNTU	8	8	2, 3 PCLKB	2 ICLK	
0008 832Ch	RIIC1	Slave address register L1	SARL1	8	8	2, 3 PCLKB	2 ICLK	
0008 832Dh	RIIC1	Slave address register U1	SARU1	8	8	2, 3 PCLKB	2 ICLK	
0008 832Eh	RIIC1	Slave address register L2	SARL2	8	8	2, 3 PCLKB	2 ICLK	
0008 832Fh	RIIC1	Slave address register U2	SARU2	8	8	2, 3 PCLKB	2 ICLK	
0008 8330h	RIIC1	I ² C bus bit rate low-level register	ICBRL	8	8	2, 3 PCLKB	2 ICLK	
0008 8331h	RIIC1	I ² C bus bit rate high-level register	ICBRH	8	8	2, 3 PCLKB	2 ICLK	
0008 8332h	RIIC1	I ² C bus transmit data register	ICDRT	8	8	2, 3 PCLKB	2 ICLK	
0008 8333h	RIIC1	I ² C bus receive data register	ICDRR	8	8	2, 3 PCLKB	2 ICLK	
0008 8340h	RIIC2	I ² C bus control register 1	ICCR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8341h	RIIC2	I ² C bus control register 2	ICCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8342h	RIIC2	I ² C bus mode register 1	ICMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8343h	RIIC2	I ² C bus mode register 2	ICMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8344h	RIIC2	I ² C bus mode register 3	ICMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 8345h	RIIC2	I ² C bus function enable register	ICFER	8	8	2, 3 PCLKB	2 ICLK	
0008 8346h	RIIC2	I ² C bus status enable register	ICSER	8	8	2, 3 PCLKB	2 ICLK	
0008 8347h	RIIC2	I ² C bus interrupt enable register	ICIER	8	8	2, 3 PCLKB	2 ICLK	
0008 8348h	RIIC2	I ² C bus status register 1	ICSR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8349h	RIIC2	I ² C bus status register 2	ICSR2	8	8	2, 3 PCLKB	2 ICLK	
0008 834Ah	RIIC2	Slave address register L0	SARL0	8	8	2, 3 PCLKB	2 ICLK	
0008 834Bh	RIIC2	Slave address register U0	SARU0	8	8	2, 3 PCLKB	2 ICLK	
0008 834Ch	RIIC2	Slave address register L1	SARL1	8	8	2, 3 PCLKB	2 ICLK	
0008 834Dh	RIIC2	Slave address register U1	SARU1	8	8	2, 3 PCLKB	2 ICLK	
0008 834Eh	RIIC2	Slave address register L2	SARL2	8	8	2, 3 PCLKB	2 ICLK	
0008 834Fh	RIIC2	Slave address register U2	SARU2	8	8	2, 3 PCLKB	2 ICLK	
0008 8350h	RIIC2	I ² C bus bit rate low-level register	ICBRL	8	8	2, 3 PCLKB	2 ICLK	
0008 8351h	RIIC2	I ² C bus bit rate high-level register	ICBRH	8	8	2, 3 PCLKB	2 ICLK	
0008 8352h	RIIC2	I ² C bus transmit data register	ICDRT	8	8	2, 3 PCLKB	2 ICLK	
0008 8353h	RIIC2	I ² C bus receive data register	ICDRR	8	8	2, 3 PCLKB	2 ICLK	
0008 8360h	RIIC3	I ² C bus control register 1	ICCR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8361h	RIIC3	I ² C bus control register 2	ICCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8362h	RIIC3	I ² C bus mode register 1	ICMR1	8	8	2, 3 PCLKB	2 ICLK	
0008 8363h	RIIC3	I ² C bus mode register 2	ICMR2	8	8	2, 3 PCLKB	2 ICLK	
0008 8364h	RIIC3	I ² C bus mode register 3	ICMR3	8	8	2, 3 PCLKB	2 ICLK	
0008 8365h	RIIC3	I ² C bus function enable register	ICFER	8	8	2, 3 PCLKB	2 ICLK	
0008 8366h	RIIC3	I ² C bus status enable register	ICSER	8	8	2, 3 PCLKB	2 ICLK	
0008 8367h	RIIC3	I ² C bus interrupt enable register	ICIER	8	8	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (31/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 C095h	PORTA	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	I/O Ports
0008 C096h	PORTB	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C097h	PORTB	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C098h	PORTC	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C099h	PORTC	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C09Ah	PORTD	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C09Bh	PORTD	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C09Ch	PORTE	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C09Dh	PORTE	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C09Eh	PORTF	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C09Fh	PORTF	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C0A0h	PORTG	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C0A1h	PORTG	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C0A4h	PORTJ	Open drain control register 0	ODR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C0A5h	PORTJ	Open drain control register 1	ODR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C0C0h	PORT0	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C1h	PORT1	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C2h	PORT2	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C3h	PORT3	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C4h	PORT4	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C5h	PORT5	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C6h	PORT6	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C7h	PORT7	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C8h	PORT8	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0C9h	PORT9	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0CAh	PORTA	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0CBh	PORTB	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0CCh	PORTC	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0CDh	PORTD	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0CEh	PORTE	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0CFh	PORTF	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0D0h	PORTG	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0D2h	PORTJ	Pull-up control register	PCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0E0h	PORT0	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0E2h	PORT2	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0E5h	PORT5	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0E9h	PORT9	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0EAh	PORTA	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	MPC
0008 C0EBh	PORTB	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0ECh	PORTC	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0EDh	PORTD	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0EEh	PORTE	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C0F0h	PORTG	Drive ability control register	DSCR	8	8	2, 3 PCLKB	2 ICLK	
0008 C100h	MPC	CS output enable register	PFCSE	8	8	2, 3 PCLKB	2 ICLK	
0008 C102h	MPC	CS output pin select register 0	PFCSS0	8	8	2, 3 PCLKB	2 ICLK	
0008 C103h	MPC	CS output pin select register 1	PFCSS1	8	8	2, 3 PCLKB	2 ICLK	
0008 C104h	MPC	Address output enable register 0	PFAOE0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C105h	MPC	Address output enable register 1	PFAOE1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C106h	MPC	External bus control register 0	PFBCR0	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C107h	MPC	External bus control register 1	PFBCR1	8	8, 16	2, 3 PCLKB	2 ICLK	
0008 C10Eh	MPC	Ethernet control register 1	PFENET	8	8	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (35/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
0008 C344h	ICU	Group 1 interrupt enable register	GEN01	32	32	1 to 2PCLKB	2 ICLK	ICUb
0008 C348h	ICU	Group 2 interrupt enable register	GEN02	32	32	1 to 2PCLKB	2 ICLK	
0008 C34Ch	ICU	Group 3 interrupt enable register	GEN03	32	32	1 to 2PCLKB	2 ICLK	
0008 C350h	ICU	Group 4 interrupt enable register	GEN04	32	32	1 to 2PCLKB	2 ICLK	
0008 C354h	ICU	Group 5 interrupt enable register	GEN05	32	32	1 to 2PCLKB	2 ICLK	
0008 C358h	ICU	Group 6 interrupt enable register	GEN06	32	32	1 to 2PCLKB	2 ICLK	
0008 C370h	ICU	Group 12 interrupt enable register	GEN12	32	32	1 to 2PCLKB	2 ICLK	
0008 C380h	ICU	Group 0 interrupt clear register	GCR00	32	32	1 to 2PCLKB	2 ICLK	
0008 C384h	ICU	Group 1 interrupt clear register	GCR01	32	32	1 to 2PCLKB	2 ICLK	
0008 C388h	ICU	Group 2 interrupt clear register	GCR02	32	32	1 to 2PCLKB	2 ICLK	
0008 C38Ch	ICU	Group 3 interrupt clear register	GCR03	32	32	1 to 2PCLKB	2 ICLK	
0008 C390h	ICU	Group 4 interrupt clear register	GCR04	32	32	1 to 2PCLKB	2 ICLK	
0008 C394h	ICU	Group 5 interrupt clear register	GCR05	32	32	1 to 2PCLKB	2 ICLK	
0008 C398h	ICU	Group 6 interrupt clear register	GCR06	32	32	1 to 2PCLKB	2 ICLK	
0008 C3C0h	ICU	Unit select register	SEL	32	32	1 to 2PCLKB	2 ICLK	
0008 C400h	RTC	64-Hz counter	R64CNT	8	8	2, 3 PCLKB	2 ICLK	RTCa
0008 C402h	RTC	Second counter	RSECCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C404h	RTC	Minute counter	RMINCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C406h	RTC	Hour counter	RHRCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C408h	RTC	Day-of-week counter	RWKCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C40Ah	RTC	Date counter	RDAYCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C40Ch	RTC	Month counter	RMONCNT	8	8	2, 3 PCLKB	2 ICLK	
0008 C40Eh	RTC	Year counter	RYRCNT	16	16	2, 3 PCLKB	2 ICLK	
0008 C410h	RTC	Second alarm register	RSECAR	8	8	2, 3 PCLKB	2 ICLK	
0008 C412h	RTC	Minute alarm register	RMINAR	8	8	2, 3 PCLKB	2 ICLK	
0008 C414h	RTC	Hour alarm register	RHRAR	8	8	2, 3 PCLKB	2 ICLK	
0008 C416h	RTC	Day-of-week alarm register	RWKAR	8	8	2, 3 PCLKB	2 ICLK	
0008 C418h	RTC	Date alarm register	RDAYAR	8	8	2, 3 PCLKB	2 ICLK	
0008 C41Ah	RTC	Month alarm register	RMONAR	8	8	2, 3 PCLKB	2 ICLK	
0008 C41Ch	RTC	Year alarm register	RYRAR	16	16	2, 3 PCLKB	2 ICLK	
0008 C41Eh	RTC	Year alarm enable register	RYRAREN	8	8	2, 3 PCLKB	2 ICLK	
0008 C422h	RTC	RTC control register 1	RCR1	8	8	2, 3 PCLKB	2 ICLK	
0008 C424h	RTC	RTC control register 2	RCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 C426h	RTC	RTC control register 3	RCR3	8	8	2, 3 PCLKB	2 ICLK	
0008 C428h	RTC	RTC control register 4	RCR4	8	8	2, 3 PCLKB	2 ICLK	
0008 C42Ah	RTC	Frequency register H	RFRH	16	16	2, 3 PCLKB	2 ICLK	
0008 C42Ch	RTC	Frequency register L	RFRL	16	16	2, 3 PCLKB	2 ICLK	
0008 C42Eh	RTC	Time error adjustment register	RADJ	8	8	2, 3 PCLKB	2 ICLK	
0008 C440h	RTC	Time capture control register 0	RTCCR0	8	8	2, 3 PCLKB	2 ICLK	
0008 C442h	RTC	Time capture control register 1	RTCCR1	8	8	2, 3 PCLKB	2 ICLK	
0008 C444h	RTC	Time capture control register 2	RTCCR2	8	8	2, 3 PCLKB	2 ICLK	
0008 C452h	RTC	Second capture register 0	RSECCP0	8	8	2, 3 PCLKB	2 ICLK	
0008 C454h	RTC	Minute capture register 0	RMINCP0	8	8	2, 3 PCLKB	2 ICLK	

Table 4.1 List of I/O Registers (Address Order) (41/50)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access States		Related Function
						ICLK≥PCLK	ICLK<PCLK	
000A 006Eh	USB0	Pipe cycle control register	PIPEPERI	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 0070h	USB0	Pipe 1 control register	PIPE1CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 0072h	USB0	Pipe 2 control register	PIPE2CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 0074h	USB0	Pipe 3 control register	PIPE3CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 0076h	USB0	Pipe 4 control register	PIPE4CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 0078h	USB0	Pipe 5 control register	PIPE5CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	USBa
000A 007Ah	USB0	Pipe 6 control register	PIPE6CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 007Ch	USB0	Pipe 7 control register	PIPE7CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 007Eh	USB0	Pipe 8 control register	PIPE8CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	
000A 0080h	USB0	Pipe 9 control register	PIPE9CTR	16	16	9 PCLKB or more	Rounded up to the nearest integer greater than 1 + 9/ (frequency ratio of ICLK/ PCLKB) ¹⁶	

Table 5.3 DC Characteristics (2)

Conditions: $V_{CC} = AVCC0 = VREFH = VCC_USB = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to $AVCC0$,
 $VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V, $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Output high voltage	All output pins	V_{OH}	$V_{CC} - 0.5$	—	V	$I_{OH} = -1$ mA
Output low voltage	All output pins (except for RIIC pins, and ETHERC)	V_{OL}	—	0.5	V	$I_{OL} = 1.0$ mA
	RIIC pins	—	—	0.4	V	$I_{OL} = 3.0$ mA
		—	—	0.6		$I_{OL} = 6.0$ mA
	RIIC pins (only P12 and P13 in channel 0)	V_{OL}	—	0.4	V	$I_{OL} = 15.0$ mA (ICFER.FMPE = 1)
		—	0.4	—		$I_{OL} = 20.0$ mA (ICFER.FMPE = 1)
	ETHERC	V_{OL}	—	0.4	V	$I_{OL} = 1.0$ mA
Input leakage current	RES#, MD pin, EMLE*1, NMI	$ I_{in} $	—	1.0	μ A	$V_{in} = 0$ V $V_{in} = V_{CC}$
Three-state leakage current (off state)	Other than ports for 5 V tolerant	$ I_{TSI} $	—	1.0	μ A	$V_{in} = 0$ V $V_{in} = V_{CC}$
	Ports for 5 V tolerant		—	5.0		$V_{in} = 0$ V $V_{in} = 5.5$ V
Input pull-up MOS current	Ports 0 to 2, 30 to 34, 36, 37, 4 to G, J3, J5	I_p	-10	—	-300	μ A $V_{CC} = 2.7$ to 3.6 V $V_{in} = 0$ V
Input capacitance	All input pins (except for ports 12, 13, 16, 17, 20, 21, 4, C0, C1, and EMLE)	C_{in}	—	—	15	pF $V_{in} = 0$ V $f = 1$ MHz $T_a = 25^\circ\text{C}$
	Ports 12, 13, 16, 17, 20, 21, 4, C0, C1, EMLE		—	—	30	
Input pull-down MOS current	EMLE, BSCANP	I_p	10	—	300	μ A $V_{in} = V_{CC}$

Note 1. The input leakage current value at the EMLE pin is only when $V_{in} = 0$ V.

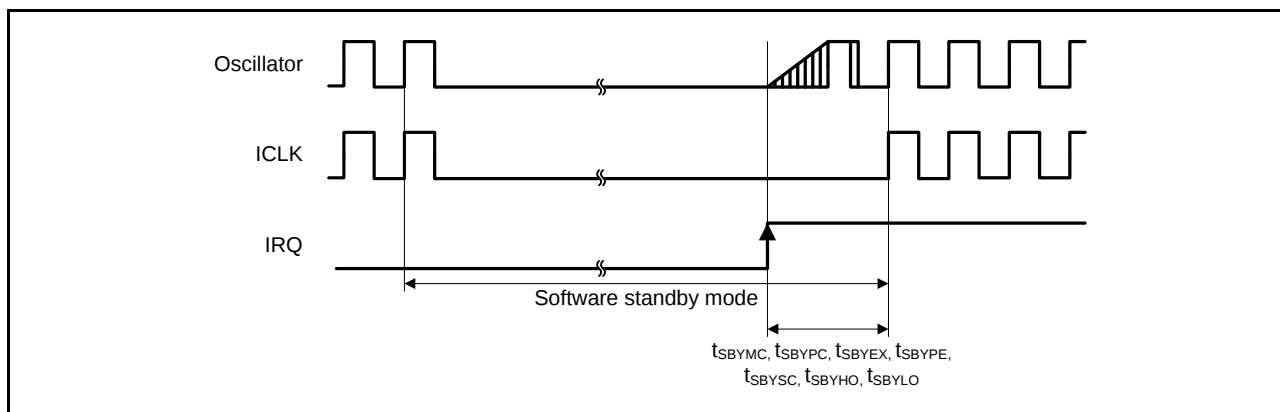


Figure 5.13 Software Standby Mode Cancellation Timing

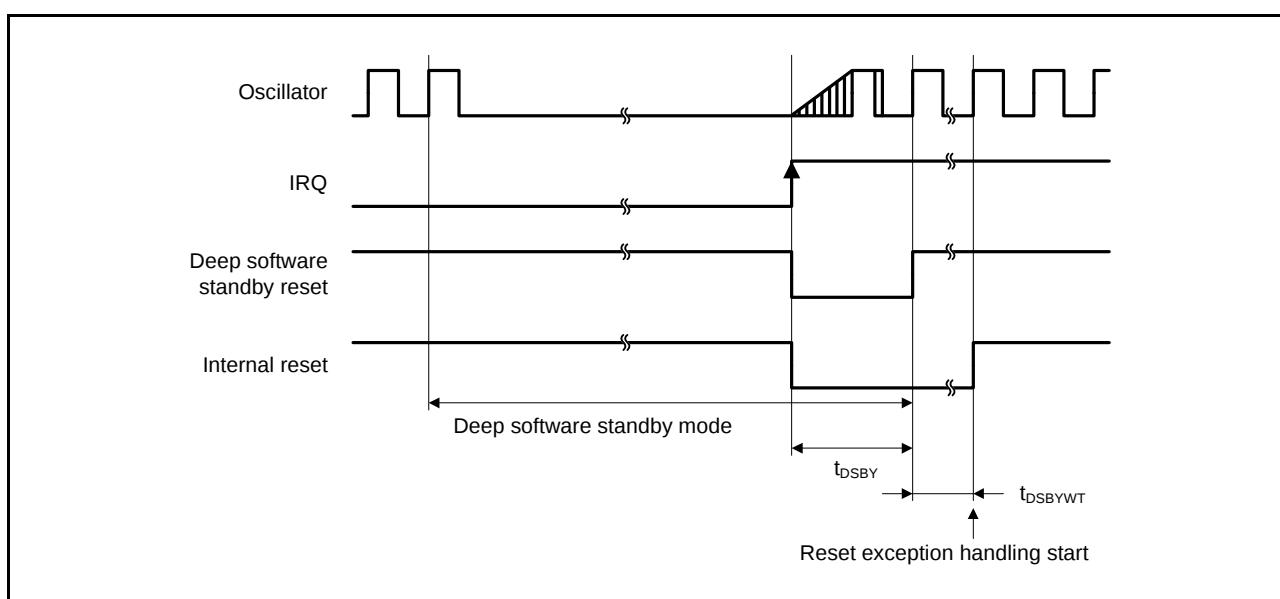


Figure 5.14 Deep Software Standby Mode Cancellation Timing

5.3.4 Control Signal Timing

Table 5.15 Control Signal Timing

Conditions: $V_{CC} = AVCC0 = VREFH = V_{CC_USB} = V_{BATT} = 2.7$ to 3.6 V, $VREFH0 = 2.7$ V to $AVCC0$,
 $VSS = AVSS0 = VREFL/VREFL0 = VSS_USB = 0$ V, $T_a = T_{opr}$

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
NMI pulse width	t_{NMIW}	200	—	—	ns	$t_c (PCLK) \times 2 \leq 200$ ns Figure 5.15
		$t_c (PCLK) \times 2$				$t_c (PCLK) \times 2 > 200$ ns Figure 5.15
IRQ pulse width	t_{IRQW}	200	—	—	ns	$t_c (PCLK) \times 2 \leq 200$ ns Figure 5.16
		$t_c (PCLK) \times 2$				$t_c (PCLK) \times 2 > 200$ ns Figure 5.16

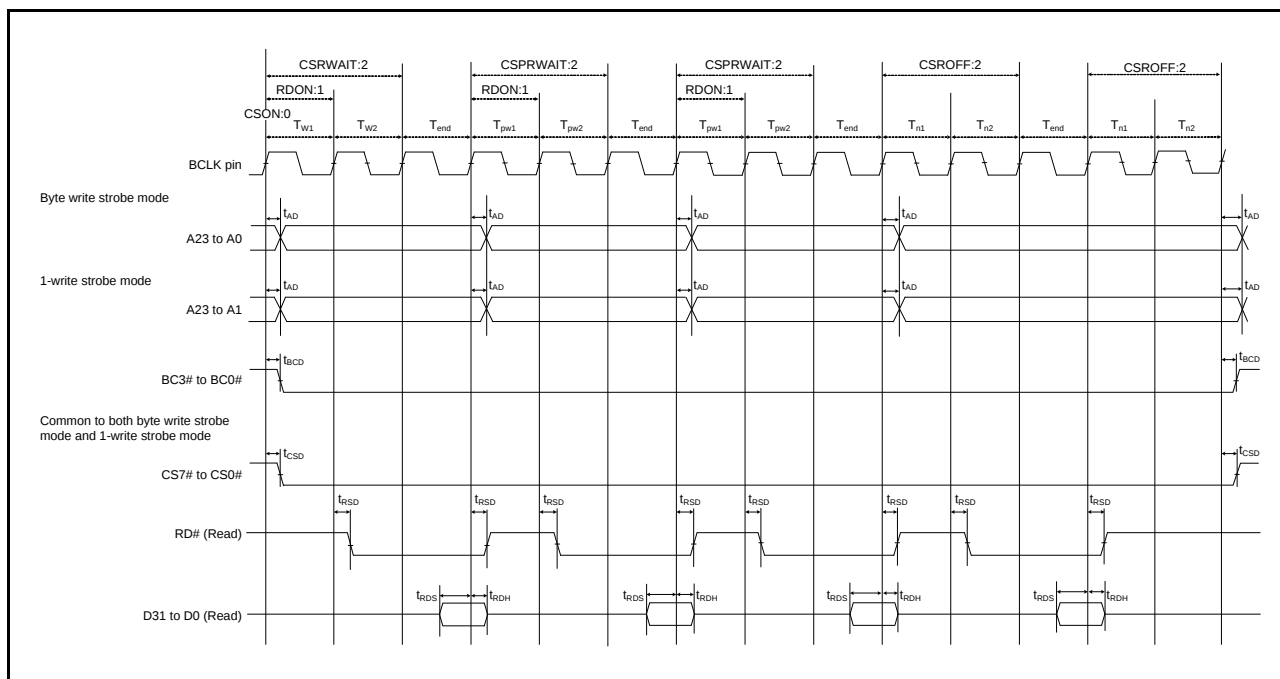


Figure 5.21 External Bus Timing/Page Read Cycle (Bus Clock Synchronized)

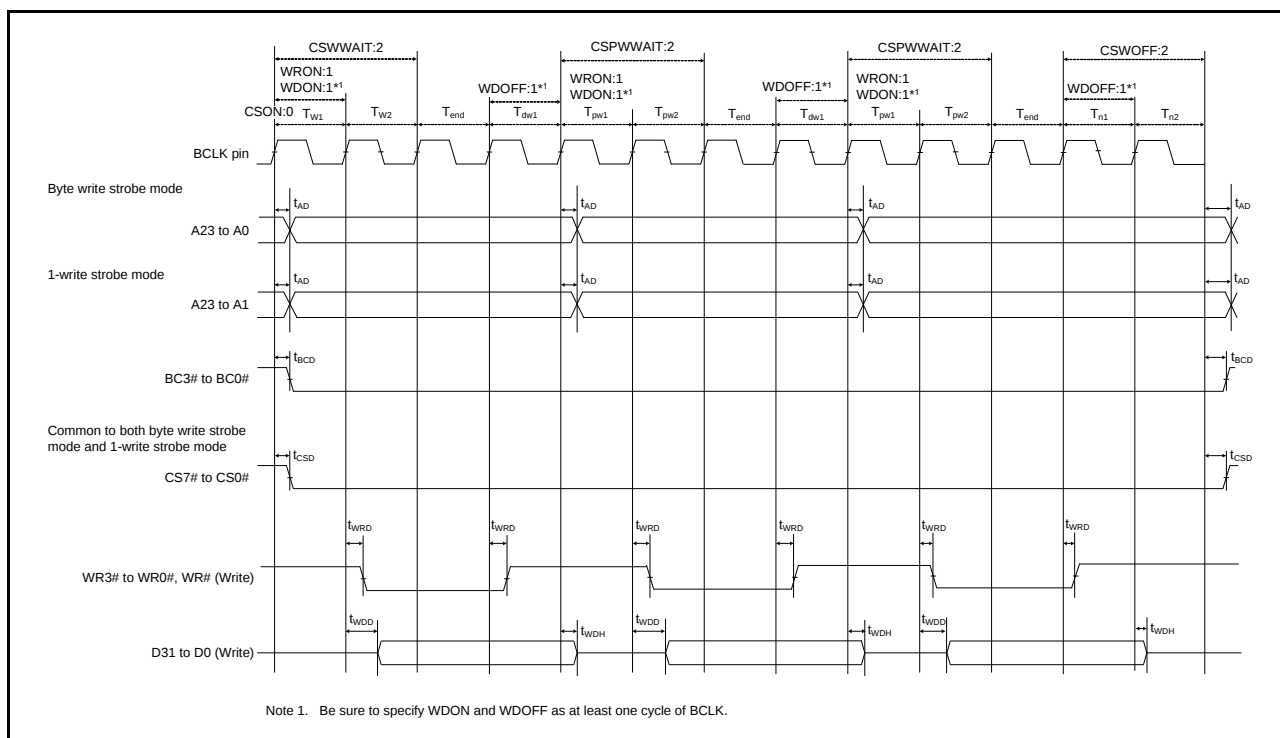


Figure 5.22 External Bus Timing/Page Write Cycle (Bus Clock Synchronized)

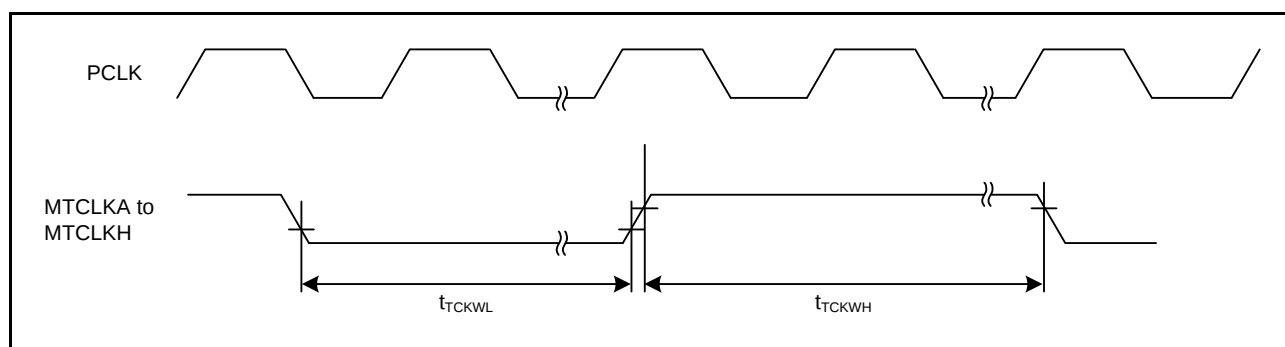


Figure 5.36 MTU Clock Input Timing

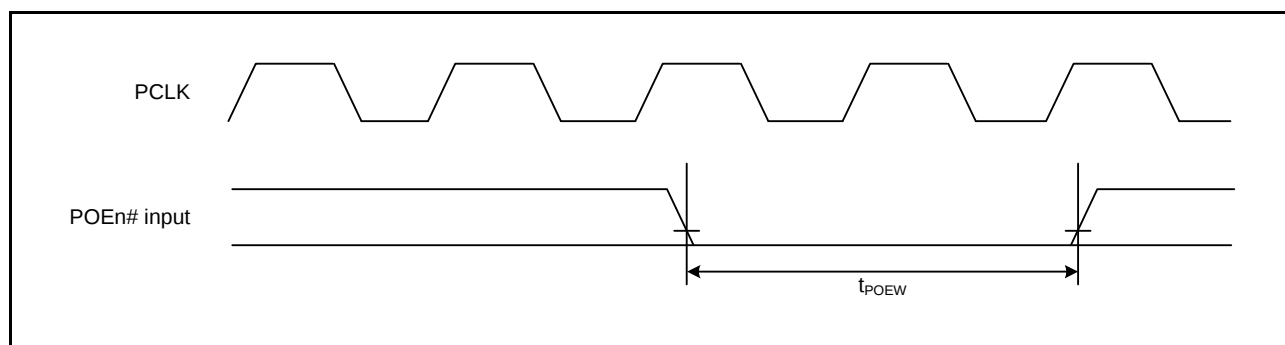


Figure 5.37 POE# Input Timing

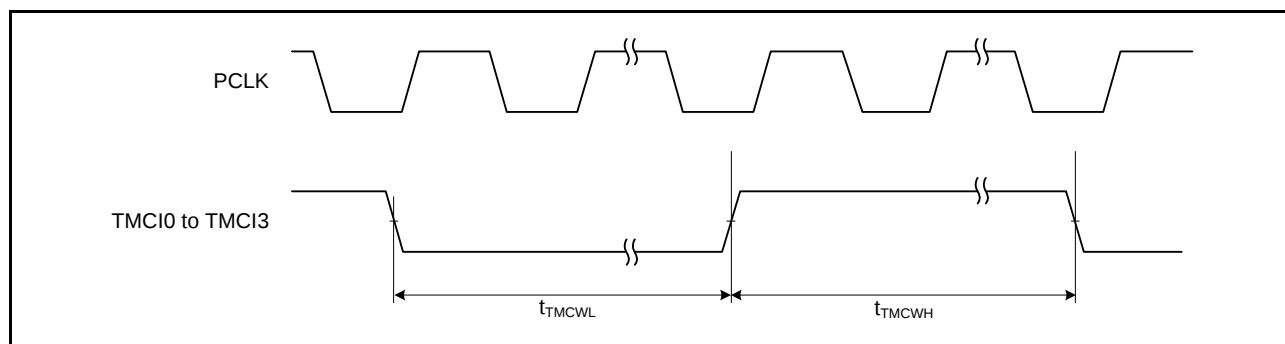


Figure 5.38 8-Bit Timer Clock Input Timing

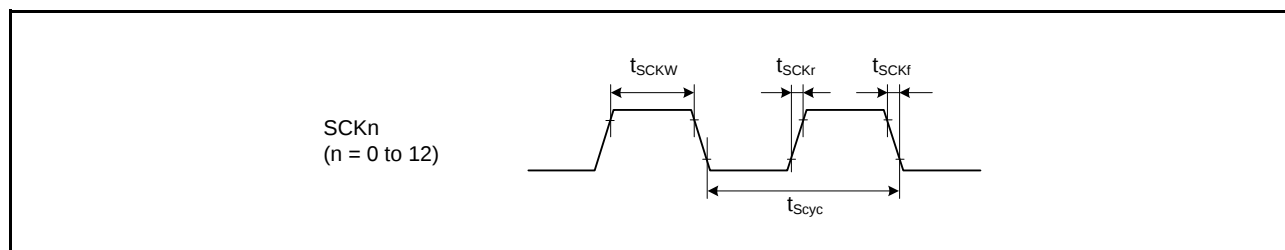


Figure 5.39 SCK Clock Input Timing

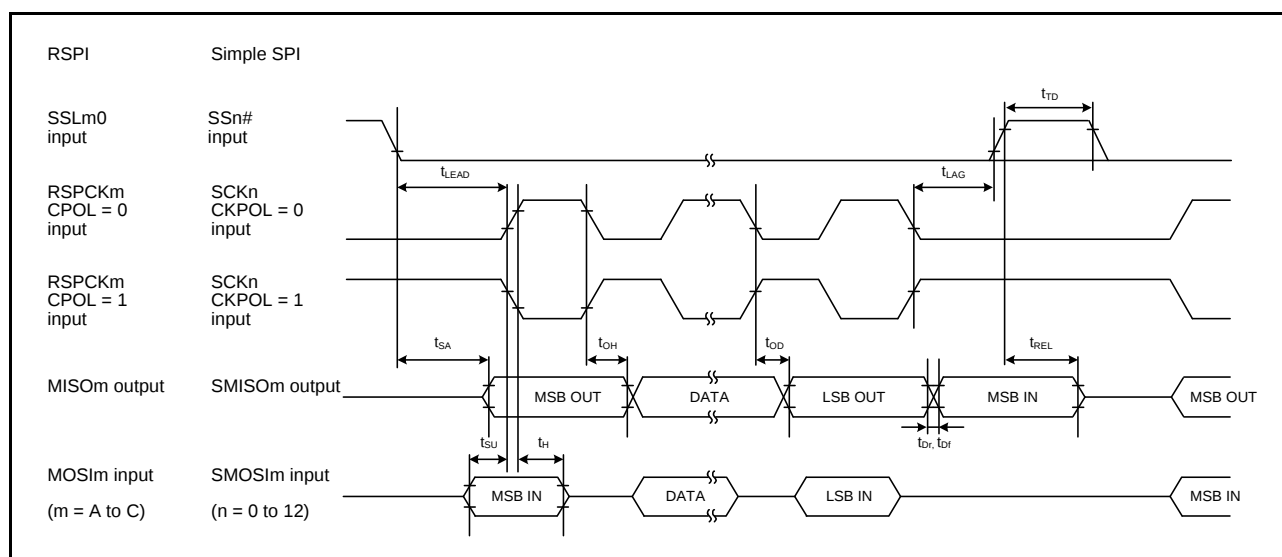


Figure 5.45 RSPi Timing (Slave, CPHA = 0) and Simple SPI Timing (Slave, CKPH = 1)

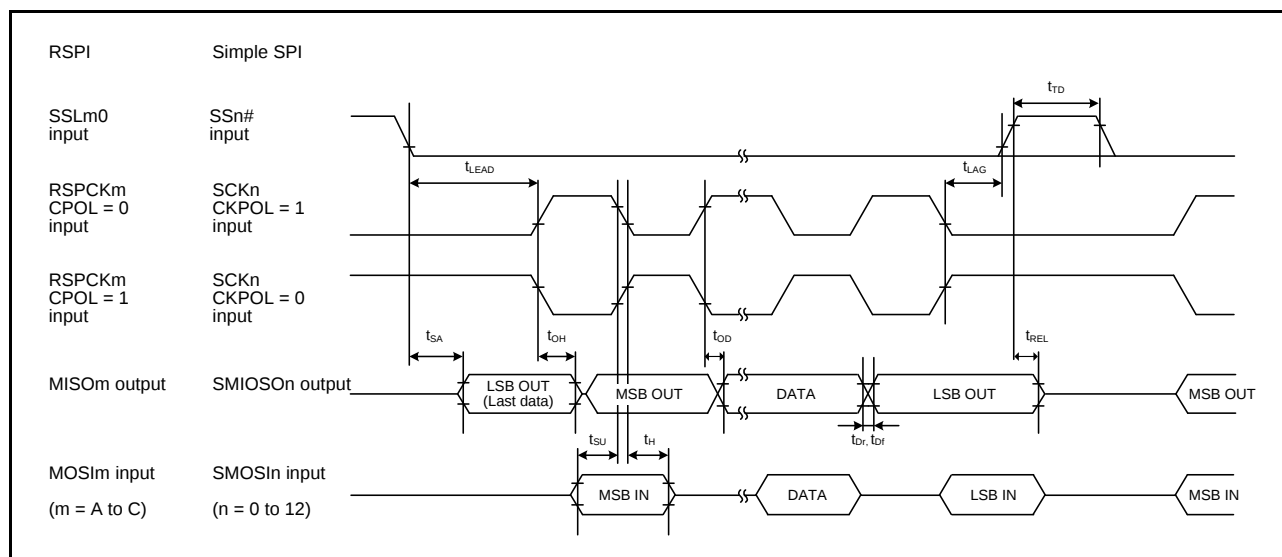


Figure 5.46 RSPi Timing (Slave, CPHA = 1) and Simple SPI Timing (Slave, CKPH = 0)

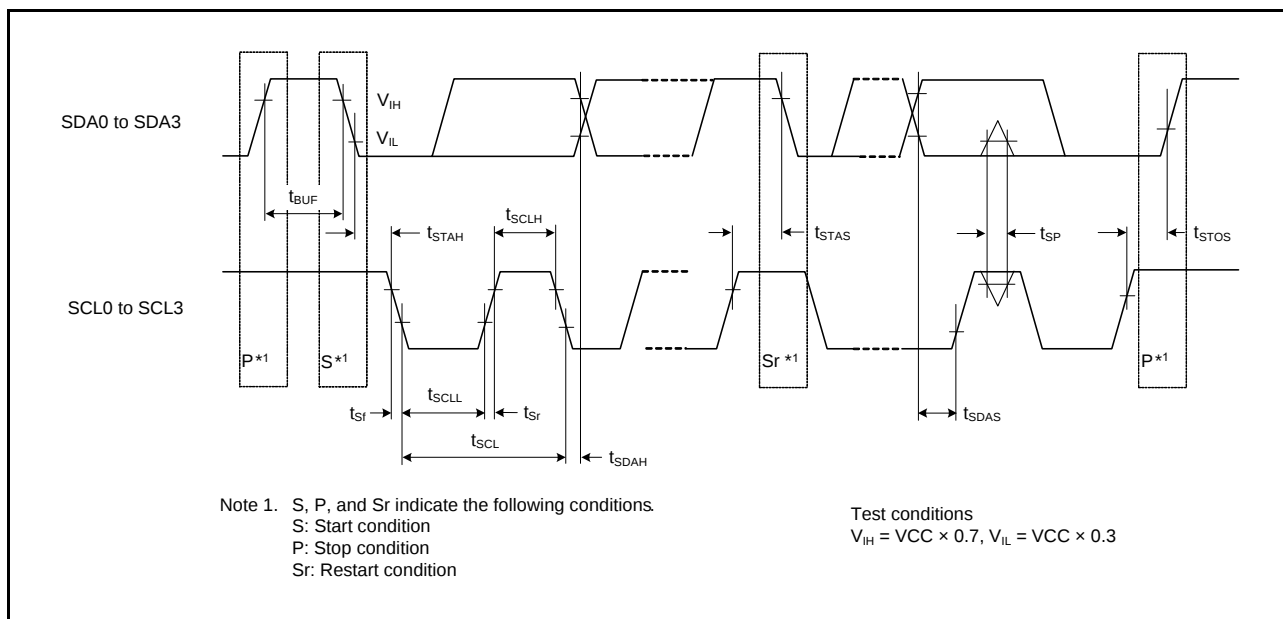


Figure 5.47 IIC Bus Interface Input/Output Timing and Simple IIC Bus Interface Input/Output Timing

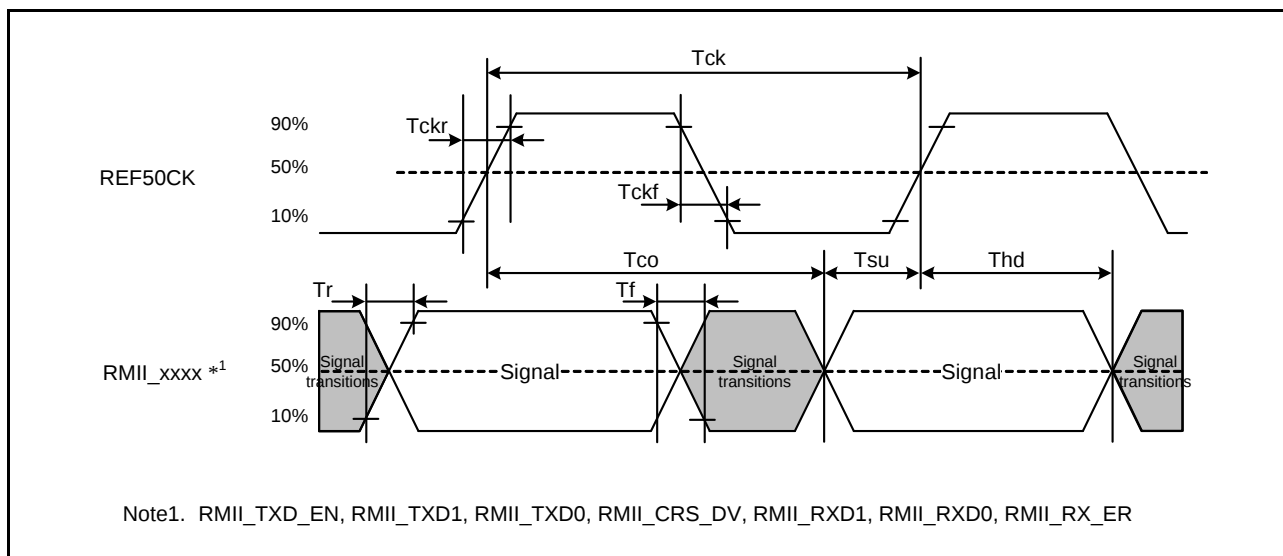


Figure 5.48 REF50CK and RMII Signal Timing

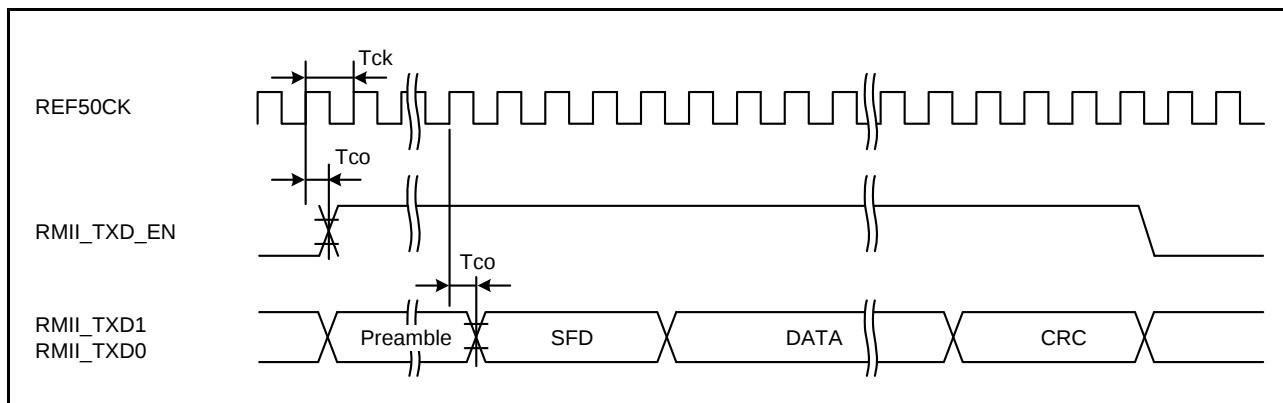


Figure 5.49 RMII Transmission Timing

REVISION HISTORY	RX63N Group, RX631 Group Datasheet
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Rev.	Date	Description	
		Page	Summary
0.50	May 13, 2011	—	First Edition issued
0.90	Dec 27, 2011	All	— Package added (177-pin TFLGA, 176-pin LFBGA, 145-pin TFLGA), module name changed — Interrupt Controller (ICUb) module name changed 1. Overview 2 to 6 Table 1.1 Outline of Specifications, Reset, Realtime clock, Temperature sensor, Power supply voltage, changed 8 to 10 Table 1.3 List of Products, changed 10 Figure 1.1 How to Read the Product Part No., changed 12 to 17 Table 1.4 Pin Functions, BSCANP pin added 18 Figure 1.3 Pin Assignment (176-Pin TFLGA), added 19 Figure 1.4 Pin Assignment (176-Pin LFBGA), added 20 Figure 1.5 Pin Assignment (176-Pin LQFP), pin 18 changed 21 Figure 1.6 Pin Assignment (144-Pin TFLGA), added 22 Figure 1.7 Pin Assignment (144-Pin LQFP), pin 16 changed 23 Figure 1.8 Pin Assignment (100-Pin LQFP), pin 7 changed 24 to 28 Table 1.5 List of Pins and Pin Functions (177-pin TFLGA, 176-pin LFBGA), added 34 to 38 Table 1.7 List of Pins and Pin Functions (145-Pin TFLGA), added 4. I/O Registers 56 to 99 Table 5.1 List of I/O Registers, changed Appendix 2. Package Dimensions 100 Figure A. 177-pin TFLGA (PTLG0177KA-A), added 101 Figure B. 176-pin LFBGA (PLBG0176GA-A), added 103 Figure D. 145-pin TFLGA (PTLG0145KA-A), added 105 Figure F. 100-pin TFLGA (PTLG0100KA-A), added
1.00	Jun 06, 2012	1. Overview	2 to 6 Table 1.1 Outline of Specifications: CPU, ROM, RAM, E2 DataFlash, clock generation circuit, temperature sensor, power supply voltage, changed. Low power consumption, deleted 8 to 10 Table 1.3 List of Products, changed 11 Figure 1.2 Block Diagram, changed 12 Table 1.4 Pin Functions, description of VCC, changed 24 to 28 Table 1.5 List of Pin and Pin Functions (177-Pin TFLGA, 176-Pin LFBGA): SDRAMC, added to table header; BCLK in pin number line M8, moved to Power Supply Clock System Control column 29 to 33 Table 1.6 List of Pin and Pin Functions (176-Pin LQFP): SDRAMC, added to table header; BCLK in pin number line 68, moved to Power Supply Clock System Control column 34 to 38 Table 1.7 List of Pin and Pin Functions (145-Pin TFLGA): SDRAMC, added to table header; MOSIB, added to pin number line D13; T_ERXD1 in pin number line H12, changed to ET_ERXD1; PO8, added to pin number line J4; BCLK in pin number line K6, moved to Power Supply Clock System Control column 39 to 43 Table 1.8 List of Pins and Pin Functions (144-Pin LQFP): SDRAMC, added to table header; PO8, added to pin number line 29; BCLK in pin number line 53, moved to Power Supply Clock System Control column; T_ERXD1 in pin number 87, changed to ET_ERXD1; MOSIB, added to pin number line 102 44 to 47 Table 1.9 List of Pins and Pin Functions (100-Pin LQFP): BCLK in pin number line 41, moved to Power Supply Clock System Control column 4. I/O Registers 57, 58 Table 4.1, MPU registers, added 5. Electrical Characteristics 105 to 163 Added

Classifications

- Items with Technical Update document number: Changes according to the corresponding issued Technical Update
- Items without Technical Update document number: Minor changes that do not require Technical Update to be issued

Rev.	Date	Description		Classification
		Page	Summary	
1.80	May 13. 2014	Features		TN-RX*-A092A/J
		1	Operating temp. range chaged, Unique ID added	
		1. Overview		
		2 to 7	Table 1.1 Outline of Specifications: Operating temperature changed, Unique ID and Note 2, added	
		8	Table 1.2 Comparison of Functions for Different Packages: Unique ID, added	
		9 to 16	Table 1.3 List of Products, changed and Note 2, added	
		17	Figure 1.1 How to Read the Product Part Number: Operating temperature range, changed	
		19, 23	Table 1.4 Pin Functions: VBATT and USB power pins, changed	
		3. Address Space		
		76	Figure 3.1 Memory Map in Each Operating Mode, changed	TN-RX*-A081A/E
		77	Figure 3.2 Correspondence between External Address Spaces and CS Areas (In On-Chip ROM Disabled Extended Mode), changed	TN-RX*-A081A/E
		5. Electrical Characteristics		TN-RX*-A097A/J
		130	Table 5.1 Absolute Maximum Ratings: Operating temperature, changed	
		131	Table 5.2 DC Characteristics (1): Note 1, chaged	
		133 to 134	Table 5.4 DC Characteristics (3) (for D and G Versions (-40 ≤ Ta ≤ +85°C)): Title	
		135 to 136	Table 5.5 DC Characteristics (4) (for G Version (-85 < Ta ≤ +105°C)), added	
		1921	Table 5.12 Clock Timing (Except for Sub-Clock Related): LOCO changed to LOCO and IWDTCCLKB	
		144	Figure 5.6 LOCO, IWDTCCLK Clock Oscillation Start Timing, added	
		189	Figure 5.68 Battery Backup Function Characteristics changed	

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